

Half-Bridge

SKiiP 27GB12T7V1

Features*

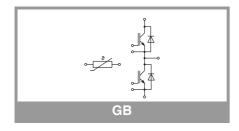
- 1200V Generation 7 IGBTs (T7)
- Robust and soft switching freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognized: File no. E63532
- NTC T-Sensor

Remarks

-)Max. case temperature limited to TC=TS=125 °C
- Product reliability results valid for Tj≤150 °C; Tj,op >150°C during overload (Details see AN19-002)
- MiniSKiiP "Technical Explanations" and "Mounting Instructions" are part of the data sheet. Please refer to both documents for further information
- For storage and case temperature with TIM see document "Technical Explanations Thermal Interface Materials"

Absolute	Maximum Ratings	S		
Symbol	Conditions		Values	Unit
Inverter -	IGBT			
V _{CES}	T _j = 25 °C		1200	V
Ic	λ _{paste} =0.8 W/(mK)	T _s = 70 °C	228	Α
	T _j = 175 °C	T _s = 100 °C	182	Α
Ic	λ _{paste} =2.5 W/(mK)	T _s = 70 °C	303	Α
	T _j = 175 °C	T _s = 100 °C	244	Α
I _{Cnom}		•	300	Α
I _{CRM}			600	Α
V _{GES}			-20 20	V
t _{psc}	$V_{CC} = 800 \text{ V}$ $V_{GE} \le 15 \text{ V}$ $V_{CES} \le 1200 \text{ V}$	T _j = 175 °C	7	μs
Tj			-40 175	°C
Inverse -	Diode			
V_{RRM}	T _j = 25 °C		1200	V
IF	λ _{paste} =0.8 W/(mK)	T _s = 70 °C	168	Α
	T _j = 175 °C	T _s = 100 °C	132	Α
IF	λ _{paste} =2.5 W/(mK)	T _s = 70 °C	209	Α
	T _j = 175 °C	T _s = 100 °C	166	Α
I _{FRM}		•	600	Α
I _{FSM}	$t_p = 10 \text{ ms, sin } 180^\circ$	°, T _j = 150 °C	1620	Α
Tj			-40 175	°C
Module				
I _{t(RMS)}	T _{terminal} = 80 °C, 20	A per spring	200	Α
T _{stg}	module without TIM	Л	-40 125	°C
V _{isol}	AC sinus 50 Hz, t =	: 1 min	2500	V

Characte	eristics						
Symbol	Conditions	min.	typ.	max.	Unit		
Inverter - IGBT							
V _{CE(sat)}	I _C = 300 A	T _j = 25 °C		1.55	1.70	V	
	V _{GE} = 15 V chiplevel	T _j = 150 °C		1.73	1.88	V	
		T _j = 175 °C		1.77	1.92	V	
V_{CE0}		T _j = 25 °C		1.00	1.05	V	
	chiplevel	T _j = 150 °C		0.80	0.85	V	
		T _j = 175 °C		0.75	0.80	V	
r _{CE}	V _{GE} = 15 V chiplevel	T _j = 25 °C		1.83	2.2	mΩ	
		T _j = 150 °C		3.1	3.4	mΩ	
		T _j = 175 °C		3.4	3.7	mΩ	
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 7 \text{ mA}$		5.15	5.8	6.45	V	
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 12$	200 V, T _j = 25 °C			3.0	mA	
C _{ies}	V _{CE} = 25 V V _{GE} = 0 V	f = 1 MHz		60.00		nF	
Coes		f = 1 MHz		0.78		nF	
C _{res}		f = 1 MHz		0.21		nF	
Q_G	V _{GE} = - 8V + 15	V	4200		nC		
R _{Gint}	T _j = 25 °C			0.5		Ω	





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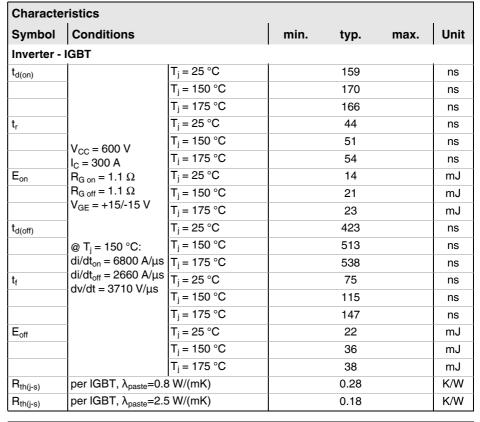
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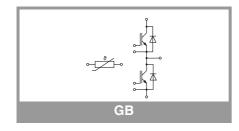
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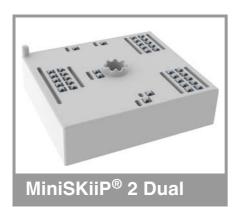
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Characte	eristics							
Symbol	Conditions		min.	typ.	max.	Unit		
Inverse - Diode								
$V_F = V_{EC}$	I _F = 300 A	T _j = 25 °C		2.14	2.46	V		
	$V_{GE} = 0 V$	T _j = 150 °C		2.07	2.38	V		
	chiplevel	T _j = 175 °C		1.93	2.24	V		
V_{F0}		T _j = 25 °C		1.30	1.50	V		
	chiplevel chiplevel I _F = 300 A V _{GE} = +15/-15 V V _{CC} = 600 V	T _j = 150 °C		0.90	1.10	V		
		T _j = 175 °C		0.82	0.98	V		
r _F		T _j = 25 °C		2.8	3.2	mΩ		
	chiplevel	T _j = 150 °C		3.9	4.3	mΩ		
		T _j = 175 °C		3.7	4.2	mΩ		
I _{RRM}		T _j = 25 °C		234		Α		
	$I_{F} = 300 \text{ A} \qquad \qquad 1$ $V_{GE} = +15/-15 \text{ V} \qquad \qquad 1$ $V_{CC} = 600 \text{ V} \qquad \qquad 1$	T _j = 150 °C		316		Α		
		T _j = 175 °C		379		Α		
Q _{rr}		T _j = 25 °C		16		μC		
		T _j = 150 °C		48		μC		
		T _j = 175 °C		47		μC		
E _{rr}	$V_{GE} = 0 \text{ V}$ $chiplevel$ $chiplevel$ $chiplevel$ $l_F = 300 \text{ A}$ $V_{GE} = +15/-15 \text{ V}$ $V_{CC} = 600 \text{ V}$ $@ T_j = 150 \text{ °C:}$ $di/dt_{off} = 6680 \text{ A/}\mu\text{s}$	T _j = 25 °C		7.2		mJ		
		T _j = 150 °C		19		mJ		
		T _j = 175 °C		23		mJ		
R _{th(j-s)}	per Diode, λ _{paste} =0.	8 W/(mK)		0.37		K/W		
R _{th(j-s)}	per Diode, λ _{paste} =2.	5 W/(mK)		0.27		K/W		
Module	•							
L _{CE}				20		nΗ		
Ms	to heat sink		2		2.5	Nm		
w				50		g		





Characteristics								
Symbol	Conditions	min. typ. max.			Unit			
Temperature Sensor								
R ₁₀₀	T _c =100°C (R ₂₅ =5 kΩ)		493 ± 5%		Ω			
B _{100/125}	$R_{(T)}=R_{100}exp[B_{100/125}(1/T-1/T_{100})];T[K];$		3550 ±2%		K			

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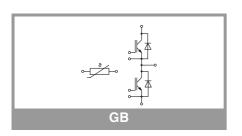
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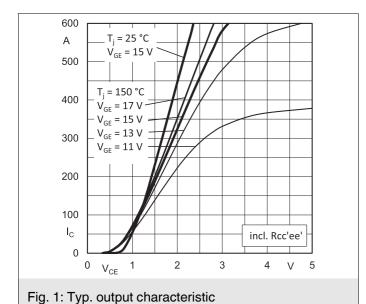
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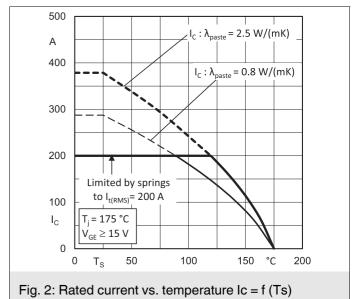
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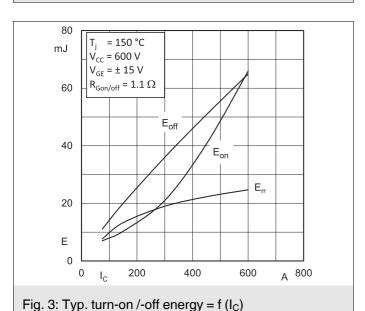
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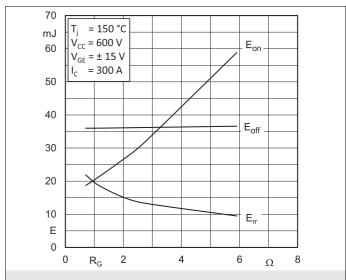
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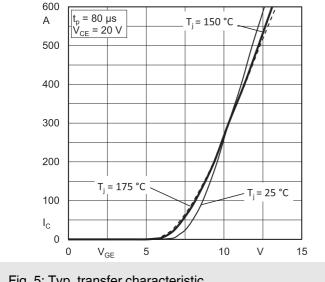


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

 $I_{\text{Cpuls}} = \overline{300 \text{ A}}$ $V_{\text{cc}} = 600 \text{ V}$

20

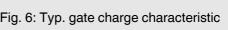
16

12

8

4

 V_{GE}



5000_{nC} 6000

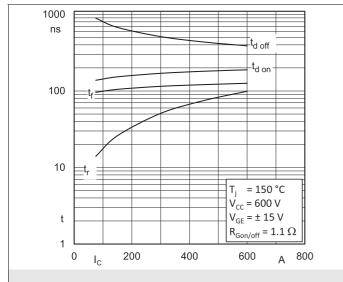


Fig. 7: Typ. switching times vs. I_C

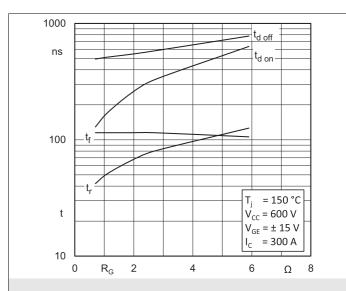


Fig. 8: Typ. switching times vs. gate resistor R_{G}

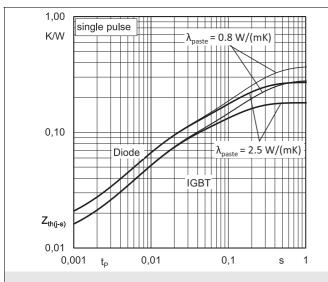


Fig. 9: Typ. transient thermal impedance

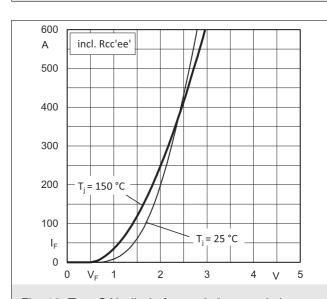


Fig. 10: Typ. CAL diode forward characteristic

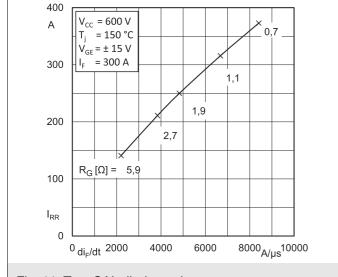


Fig. 11: Typ. CAL diode peak reverse recovery current

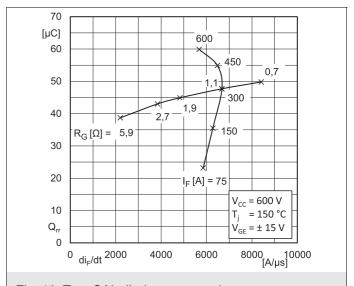
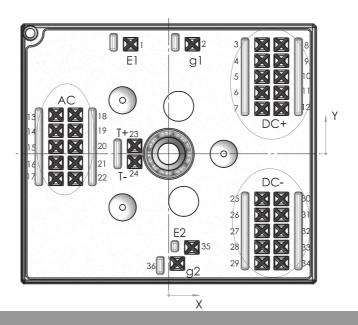


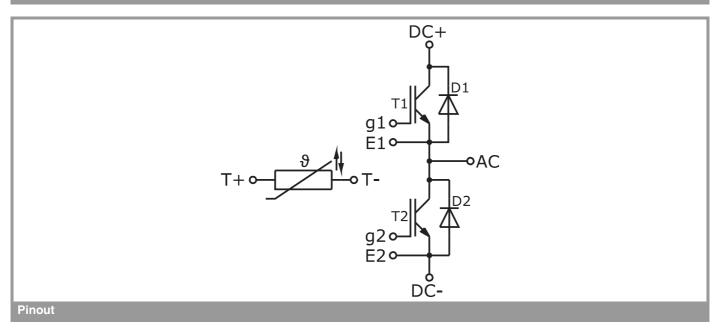
Fig. 12: Typ. CAL diode recovery charge

Pin out							
Pin	X	Y	Function	Pin	X	Υ	Function
1	-7,58	21,9	E1	19	-18,62	4,6	AC
2	4,72	21,9	g1	20	-18,62	1,4	AC
3	18,62	21,8	DC+	21	-18,62	-1,8	AC
4	18,62	18,6	DC+	22	-18,62	-5	AC
5	18,62	15,4	DC+	23	-6,78	1,6	T+
6	18,62	12,2	DC+	24	-6,78	-1,6	T-
7	18,62	9	DC+	25	18,62	-9	DC-
8	22,48	21,8	DC+	26	18,62	-12,2	DC-
9	22,48	18,6	DC+	27	18,62	-15,4	DC-
10	22,48	15,4	DC+	28	18,62	-18,6	DC-
11	22,48	12,2	DC+	29	18,62	-21,8	DC-
12	22,48	9	DC+	30	22,48	-9	DC-
13	-22,48	7,8	AC	31	22,48	-12,2	DC-
14	-22,48	4,6	AC	32	22,48	-15,4	DC-
15	-22,48	1,4	AC	33	22,48	-18,6	DC-
16	-22,48	-1,8	AC	34	22,48	-21,8	DC-
17	-22,48	-5	AC	35	4,62	-18,7	E2
18	-18,62	7,8	AC	36	1,72	-21,9	g2

all values in mm



Pinout and Dimensions



This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

*IMPORTANT INFORMATION AND WARNINGS

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